

POSTSECONDARY ENROLLMENT PROGRAMS

The Board recognizes the value to students and to the District for students to participate in programs offered by accredited colleges ~~and universities~~. The Superintendent will annually develop/revise articulation agreements jointly with postsecondary institutions to provide a comprehensive articulated acceleration program including, but not limited to, dual enrollment and early admission programs.

The Board will approve participation by students in grades 10, 11, and 12 who meet the State Board of Education's criteria, to enroll in approved postsecondary programs while in attendance in the District. Students will be eligible to receive secondary credit for completing courses contained in any of these programs. Such credit will count toward graduation requirements.

No student may participate without the written consent of parents and the high school principal.

The Superintendent shall establish the necessary administrative procedures to comply with State law which will thereafter be properly communicated to both students and their parents.

The postsecondary education institution will assign a letter grade for the student's work in the course, and the District will be responsible for posting dual enrollment course grades as assigned by the postsecondary institution to the high school transcript. The Superintendent shall also establish procedures for the awarding of credit and the proper entry on a student's transcript and other records of his/her participation in a postsecondary program.

The District shall deny high school credit for any portion of postsecondary courses which are taken during the period of a student's expulsion. Any District student who is expelled is not eligible for enrollment or continuation in postsecondary courses during the period of expulsion except as determined by mutual agreement between the District and the college ~~or university~~.

The Superintendent shall develop and update as needed administrative procedures to implement this policy.

F.S. 1007.27, 1007.271

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